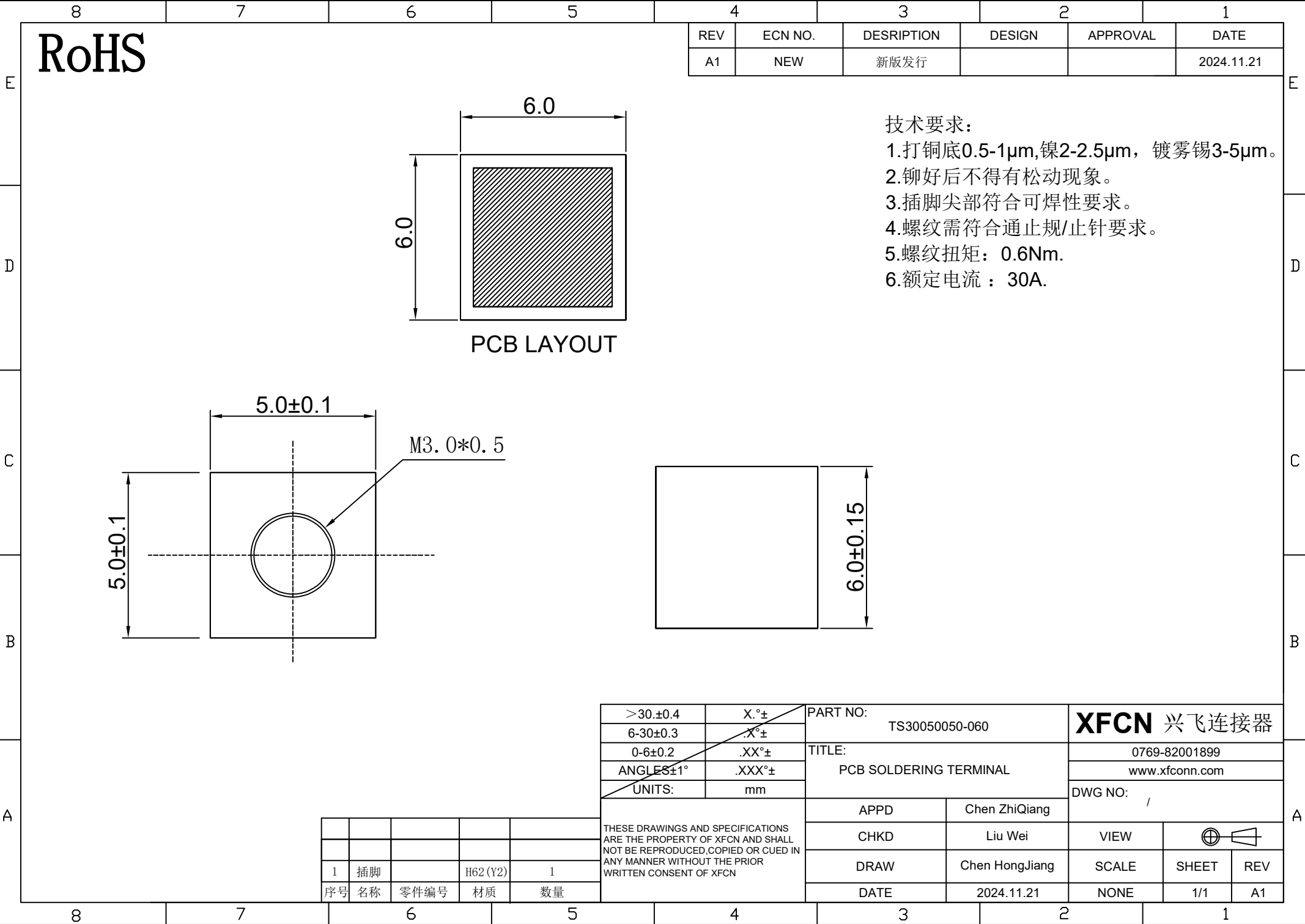
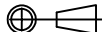




RoHS

PCB LAYOUT

- 技术要求：
- 1.打铜底0.5-1μm,镍2-2.5μm, 镀雾锡3-5μm。
 - 2.铆好后不得有松动现象。
 - 3.插脚尖部符合可焊性要求。
 - 4.螺纹需符合通止规/止针要求。
 - 5.螺纹扭矩：0.6Nm.
 - 6.额定电流：30A.

>30.±0.4	X.°±	PART NO: TS30050050-060		XFCN 兴飞连接器				
6-30±0.3	.X°±							
0-6±0.2	.XX°±	TITLE: PCB SOLDERING TERMINAL		0769-82001899				
ANGLES±1°	.XXX°±			www.xfconn.com				
UNITS:	mm	APPD Chen ZhiQiang		DWG NO: /				
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF XFCN AND SHALL NOT BE REPRODUCED.COPIED OR CUED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF XFCN				CHKD Liu Wei		VIEW		
				DRAW Chen HongJiang		SCALE	SHEET	REV
				DATE 2024.11.21		NONE	1/1	A1